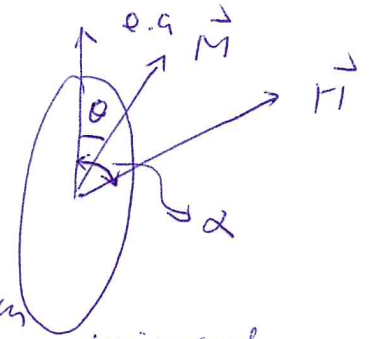


①

1. a) α : e.u. & \vec{H}
 θ : \vec{M} & e.u.



M_s : saturation magnetization
 H : external field ; K_u : uniaxial magnetiz anisotropy

Total energy
$$E = K_u \sin^2 \theta - M_s H \cos(\alpha - \theta)$$

$$\frac{\partial E}{\partial \theta} = 2K_u \sin \theta \cos \theta - H M_s \sin(\alpha - \theta) = 0$$

$$M = M_s \cos(\alpha - \theta)$$

$\alpha = 90^\circ$. $2K_u (M/M_s) = H M_s$

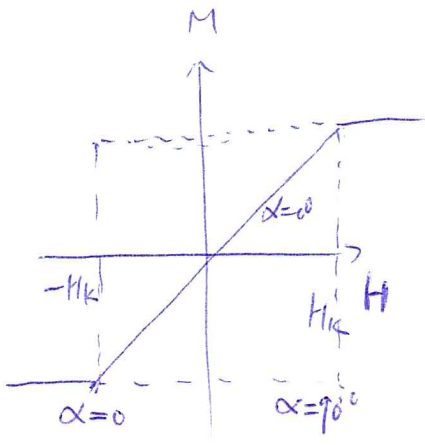
$$M/M_s = H/H_k \quad H_k = \frac{2K_u}{M_s}$$

linear , hard axis

$\alpha = 0^\circ$ $2K_u \sin \theta \cos \theta + M_s H \sin \theta = 0$ $\frac{\partial^2 E}{\partial \theta^2} > 0$ (min)
 $\sin \theta = 0$; $E = M_s H$
 $\cos \theta = -\frac{M_s H}{2}$; $E = K_u + \frac{M_s^2 H^2}{4K_u}$ $\frac{\partial^2 E}{\partial \theta^2} < 0$ (max)

$$\begin{aligned} \Delta E &= K_u - M_s H + \frac{M_s^2 H^2}{4K_u} \\ &= K_u \left(1 - \frac{M_s H}{K_u} + \frac{M_s^2 H^2}{4K_u^2} \right) \\ &= K_u \left(1 - \frac{H}{H_k} \right)^2 \end{aligned}$$

$$H_k = \frac{2K_u}{M_s}$$



(2)

1. b).
$$P_{\text{switch}} = f_0 \tau e^{-\Delta E / k_B T}$$

c) Coercivity point \rightarrow half switch point.

$$\frac{1}{2} = f_0 \tau e^{-\Delta E / k_B T}$$

$$\Delta E = k_B T \ln(2 f_0 \tau)$$

$$\Delta E = K_u \cdot V \left(1 - \frac{H}{H_K}\right)^2 = k_B T \ln(2 f_0 \tau)$$

$$H = H_K \left[1 - \left(\frac{k_B T}{K_u V} \cdot \ln(2 f_0 \tau)\right)^{\frac{1}{2}}\right]$$

d) two of the following three candidates.

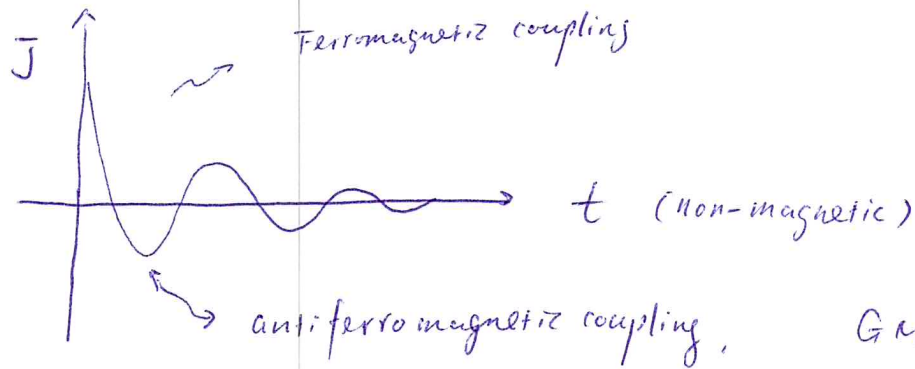
- 1) stress anisotropy; (lattice mismatch between two layers)
- 2) Interface anisotropy; (e.g. CoFeB/MgO)
- 3) shape anisotropy; ($t < 1.5 \text{ nm}$, patterned structure, ultrathin film)

e) $H_c^{\text{single}} > H_c^{\text{packed}}$

$$H_c^{\text{packed}} \propto (1 - P) H_c^{\text{single}} \quad \leftarrow \text{shape anisotropy dominant case}$$

P : packing density.

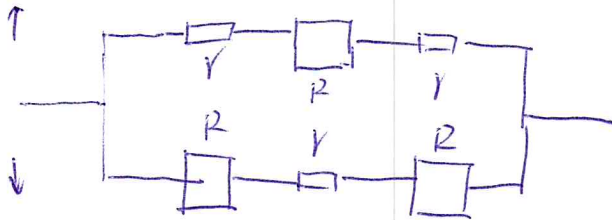
2. a) RKKY interaction.



GMR working region.

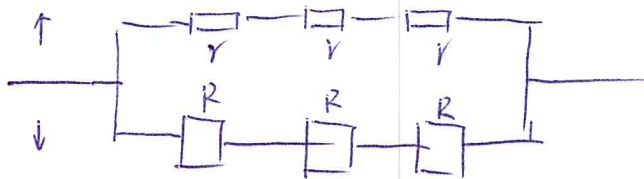
b) For AP configuration.

two-resistor model



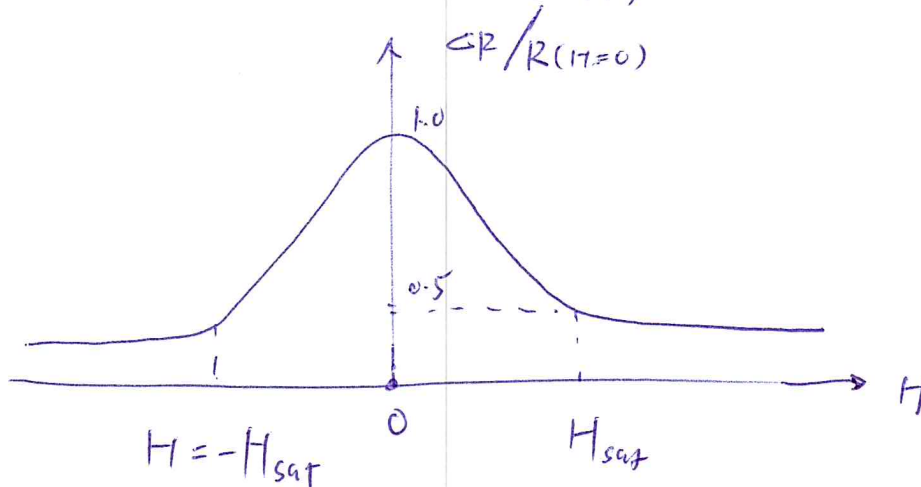
$$R_{AP} = (2Y+R) // (2R+Y) \\ = \frac{(2Y+R)(R+2R)}{3(Y+R)}$$

For P configuration.

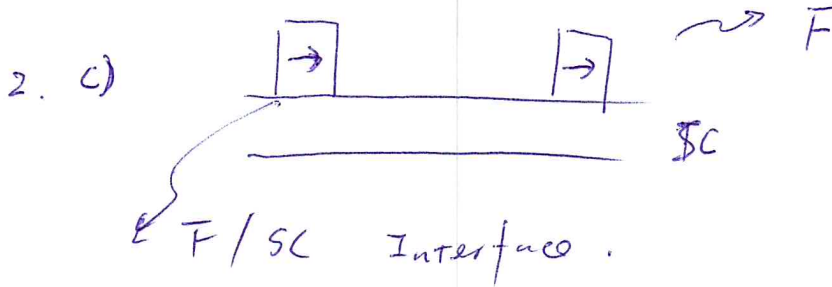


$$R_P = 3R // 3R = \frac{9R \cdot Y}{3(Y+R)}$$

$$\Delta R = R_{AP} - R_P = \frac{2(R-Y)^2}{3(R+Y)}$$



(4)



F: metal; conductance: G_F

SC: semiconductor; conductance: G_{SC}

$G_F \gg G_{SC}$ a large conductance mismatch between F & SC layers.

spin injection will be very inefficient.

solution: to add a tunneling barrier between F & SC layer.

Basically, we could not identify the ^{spin-dependent} resistance or scattering because:

$$R_{SC} + R_{FP} \approx R_{SE} + R_{FI}$$